

SEMICONDUCTOR®

November 2013

FQAF13N80 — N-Channel QFET[®] MOSFET

FQAF13N80

N-Channel QFET[®] MOSFET

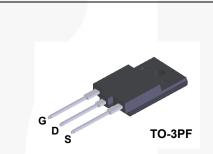
 $800~V,\,8.0~A,\,750~m\Omega$

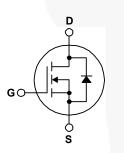
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 8.0 A, 800 V, $R_{DS(on)}$ = 750 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 4.0 A
- Low Gate Charge (Typ. 68 nC)
- Low Crss (Typ. 30 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter	FQAF13N80	Unit	
V _{DSS}	Drain-Source Voltage	800	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}$	C)	8.0	А
	- Continuous (T _C = 100)°C)	5.1	A
I _{DM}	Drain Current - Pulsed	(Note 1)	32	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	1100	mJ
AR	Avalanche Current	(Note 1)	8.0	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)) 120	
	- Derate above 25°C	0.96	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Rar	-55 to +150		
Τ _L	Maximum lead temperature for soldering 1/8" from case for 5 seconds	300	°C	

Thermal Characteristics

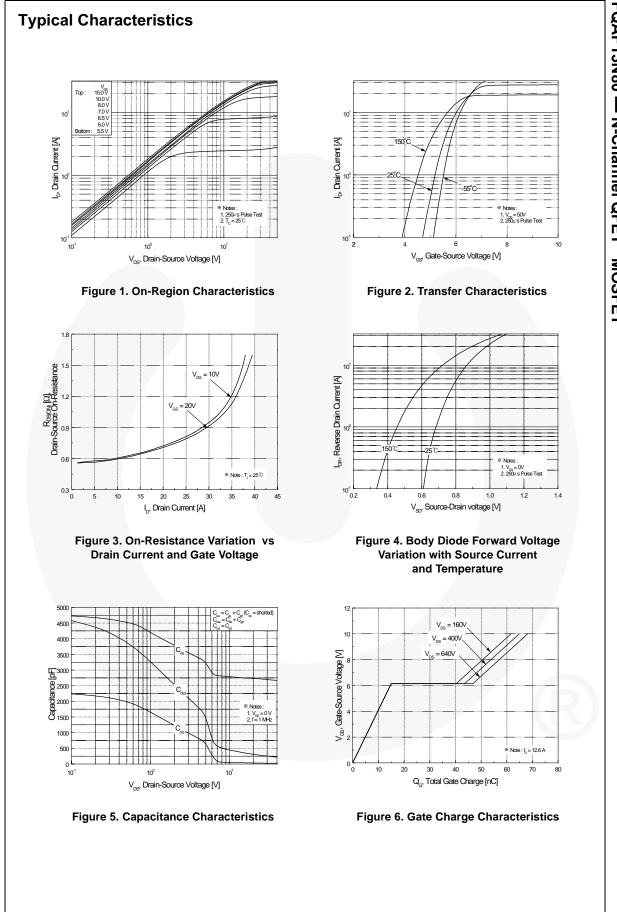
Symbol	Parameter	FQAF13N80	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.04	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

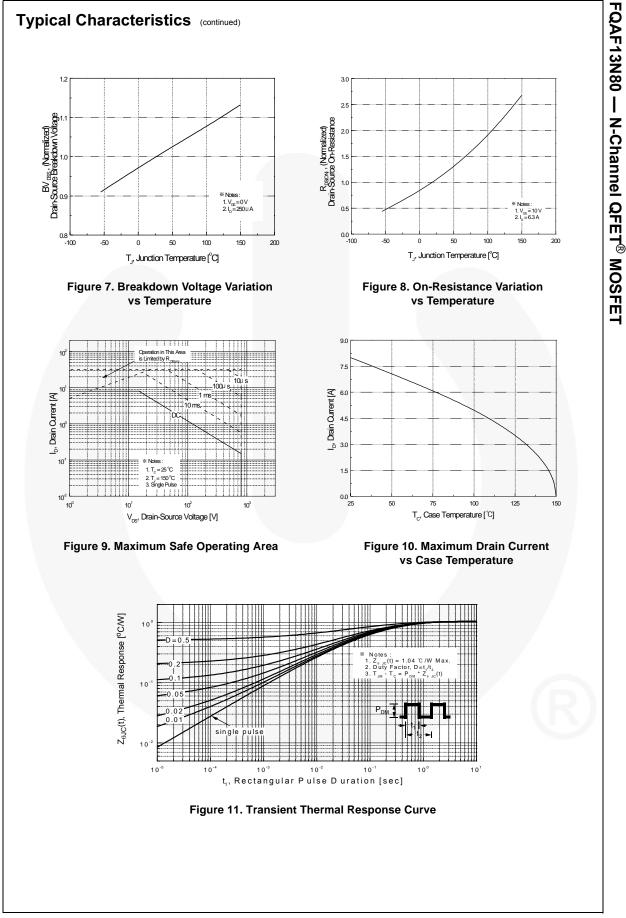
Part Number		Top Mark	Pack	age	Packing Method	Reel	Size	Tape W	idth	Quantity
FQAF1			TO-3			N/.	A	N/A		30 units
Electri	cal Cł	naracteristics	_c = 25°C un	less otherw	ise noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
Off Cha	aractori	etice						,		
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 μA		800			V		
ΔBV_{DSS}					000			v		
$/ \Delta T_{J}$		Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu A$, Referenced to 25°C			0.95		V/°C	
I _{DSS}	Zoro C			$V_{DS} =$	800 V, V _{GS} = 0 V				10	μA
	Zero Gate Voltage Drain Current		fil	$V_{DS} =$	640 V, T _C = 125°C				100	μΑ
I _{GSSF}	Gate-B	ody Leakage Current, I	orward		30 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-B	ody Leakage Current, I	Reverse	$V_{GS} =$	-30 V, V _{DS} = 0 V				-100	nA
On Cha	racteri	stics								
V _{GS(th)}		hreshold Voltage	_	V _{DS} =	V _{GS} , I _D = 250 μA		3.0		5.0	V
R _{DS(on)}	Static D	Drain-Source		-	10 V, I _D = 4.0 A			0.58	0.75	Ω
9 _{FS}		rd Transconductance		V _{DS} = 50 V, I _D = 4.0 A			10.5		S	
C _{iss}	Input C	acteristics	_	V _{DS} = 25 V, V _{GS} = 0 V,			2700	3500		
C _{oss}		Capacitance e Transfer Capacitance		f = 1.0 MHz				275	360	pF
C _{rss}	Revers							30	39	pF
Switchi	ing Cha	aracteristics								
	Turn-O	n Delay Time		V	400 V, I _D = 12.6 A,			60	130	ns
t _{d(on)}	Turn-O	n Rise Time		$P_{DD} = 2$	-			150	310	ns
					0 12			155	320	ns
t _r	Turn-O	ff Delay Time						110	230	ns
t _r t _{d(off)}						(Note 4)		110		_
t _r	Turn-O	ff Delay Time		V _{DS} =	640 V, I _D = 12.6 A,	(Note 4)		68	88	nC
t _r t _{d(off)} t _f Q _g	Turn-O Total G	ff Delay Time ff Fall Time		V _{DS} = V _{GS} =	640 V, I _D = 12.6 A, 10 V	(Note 4)			88 	nC nC
	Turn-O Total G Gate-S	ff Delay Time ff Fall Time ate Charge		-		(Note 4) (Note 4)		68		_
t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Turn-O Total G Gate-S Gate-D	ff Delay Time ff Fall Time ate Charge ource Charge rain Charge	stics ar	V _{GS} =	10 V	(Note 4)		68 15		nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-O Total G Gate-S Gate-D	ff Delay Time ff Fall Time ate Charge ource Charge		V _{GS} =	10 ∨ Kimum Ratings	(Note 4)		68 15		nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-O Total G Gate-S Gate-D Gource Maximu	ff Delay Time ff Fall Time ate Charge ource Charge rain Charge Diode Characteri	ource Dic	V _{GS} =	10 V Kimum Ratings	(Note 4)		68 15 32		nC nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \end{array} \\ \hline \textbf{Drain-S} \\ I_S \\ I_{SM} \end{array}$	Turn-O Total G Gate-S Gate-D OUTCE Maximu Maximu	ff Delay Time ff Fall Time ate Charge ource Charge rain Charge Diode Characteri um Continuous Drain-S	ource Dic e Diode F	V _{GS} =	10 V Kimum Ratings	(Note 4)		68 15 32 	8.0	nC nC
$\begin{array}{c} t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_{gs} \\ Q_{gd} \\ \end{array} \\ \hline \textbf{Drain-S} \\ I_S \end{array}$	Turn-O Total G Gate-S Gate-D Ource Maximu Maximu Drain-S	ff Delay Time ff Fall Time ate Charge ource Charge rain Charge Diode Characteri um Continuous Drain-S um Pulsed Drain-Sourc	ource Dic e Diode F	$V_{GS} =$ nd Max ode Forw Forward ($V_{GS} =$	10 V timum Ratings ard Current Current	(Note 4)		68 15 32 	 8.0 36	nC nC A A

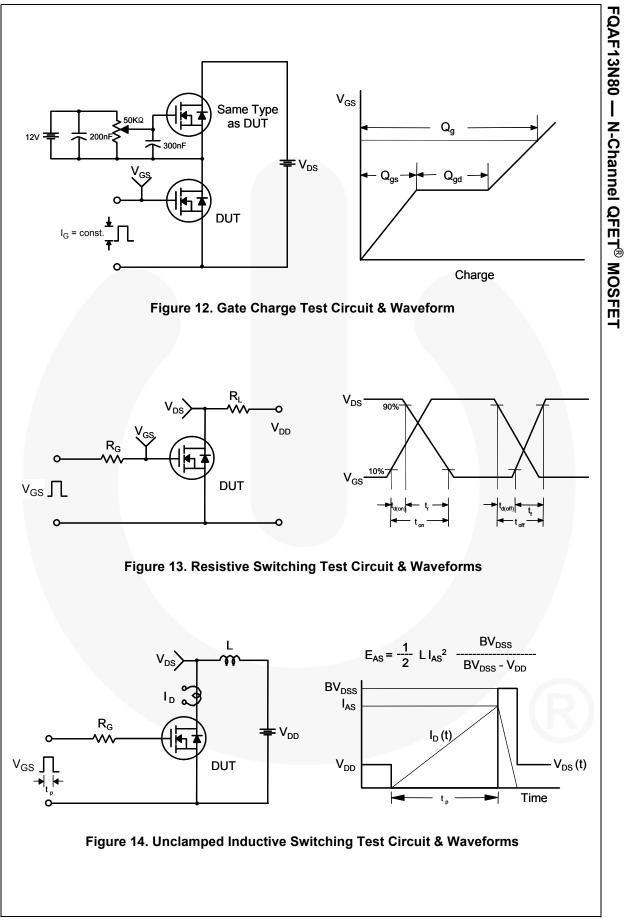
 $\label{eq:Notes: 1.5} \begin{array}{l} \textbf{Notes:} \\ 1. Repetitive Rating : Pulse width limited by maximum junction temperature \\ 2. L = 32 mH, I_{AS} = 8.0 \text{ A}, V_{DD} = 50 \text{ V}, R_{G} = 25 \,\Omega, \text{ Starting } T_J = 25^{\circ}\text{C} \\ 3. I_{SD} \leq 12.6 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, V_{DD} \leq \text{BV}_{DSS}, \text{ Starting } T_J = 25^{\circ}\text{C} \\ 4. \text{ Essentially independent of operating temperature} \end{array}$

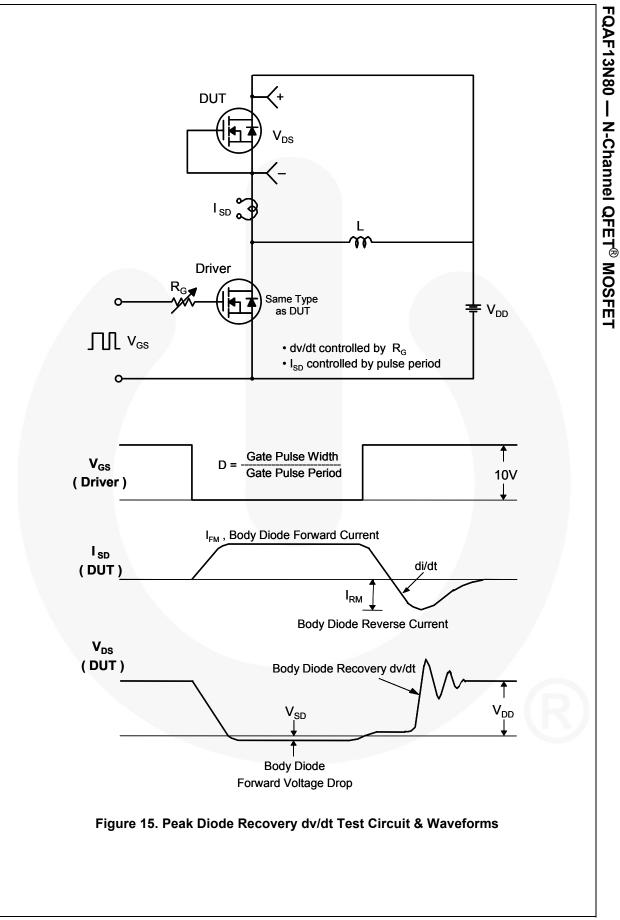
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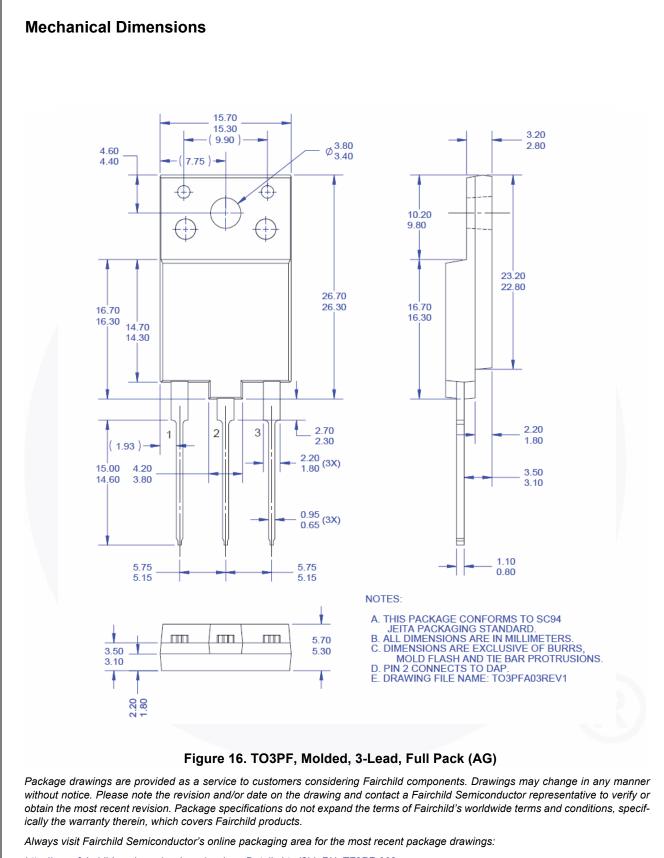
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http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TF3PF-003

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	·	Rev. 166

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